

IEEE P802.3ck Ad Hoc meeting – August 28, 2019

Prepared by Kent Lusted and Shawn Nicholl

Proposed Agenda:

- Approval of the Agenda
- Approve 14 August 2019 ad hoc minutes
- IEEE Patent Policy reminder:
 - <http://www.ieee802.org/3/patent.html>
- IEEE Participation Requirements reminder
- Logistics for September interim meeting
- .3ck Ad Hoc –
 - “Examples of C2C Channels With Impairments 10dB 16dB 18dB 20dB Test Cases”, Rick Rabinovich
 - “100G C2M Simulations”, Femi Akinwale

Presentations posted at: <http://www.ieee802.org/3/ck/public/adhoc/index.html>

Meeting began at ~7:00 a.m. Pacific by Kent Lusted.

Meeting began with the agenda presentation:

http://www.ieee802.org/3/ck/public/adhoc/aug28_19/agenda_082819_3ck_adhoc.pdf

The ad hoc chair reminded participants to indicate full names and employer/affiliation correctly for the meeting minutes. Reminded participants to mute lines when not speaking and reviewed the steps to unmute.

Presented the proposed agenda. No one responded. The agenda was approved by the ad hoc.

The ad hoc chair noted that the August 14, 2019 minutes were posted. He asked if there were corrections or modifications. No one responded. Minutes were approved by the Task Force.

Reminded participants of the IEEE patent policy. He asked if anyone was unfamiliar with the IEEE patent policy. No one responded.

Reminded participants of the IEEE Participation Requirements and showed the slide with the Participation requirements. He asked if anyone was unfamiliar with the IEEE Participation Requirements. No one responded.

Agenda Items

P802.3ck Update, Kent Lusted

See: http://www.ieee802.org/3/ck/public/adhoc/aug28_19/agenda_082819_3ck_adhoc.pdf

- Task Force will meet week of September 9, 2019 in Indianapolis, IN, USA. P802.3ck is meeting Wednesday through Friday.
- Goal is to adopt additional baselines to allow for creation of draft 1.0
- Presentation requests are due Friday, August 30th AOE
- Presentation submissions are due by 5:00pm PDT Tuesday, Sept 3rd.
- There is no social event during the September Interim
- There was a request to avoid scheduling C2M and FEC discussions for Wed morning.

Presentation #1:

“Examples of C2C Channels With Impairments 10dB 16dB 18dB 20dB Test Cases”, Rick Rabinovich

See: http://www.ieee802.org/3/ck/public/adhoc/aug28_19/rabinovich_3ck_adhoc_01_082819.pdf

- There was a request to update the presentation (eg. slide 9) to emphasize that these results are for the set of channels shown, and results may be different for other channels
- It was noted that the DER assumption was 1E-5 with CL91 FEC.
- It was noted that 25ps rise time was used; Request to repeat the experiments using 10ps
- Discussed going beyond 20dB IL. There was concern that glass weave and manufacturing variability were not included in the analysis.
- The adhoc chair noted that all four channels are posted to the task force website in a single zip file under Chip to Chip Channels section of the [Tools and Channels](#) page

Presentation #2:

“100G C2M Simulations”, Femi Akinwale

See: http://www.ieee802.org/3/ck/public/adhoc/aug28_19/akinwale_3ck_adhoc_01a_08282019.pdf

- On slide 5, the x-axis was PCB length not package length. The x-axis lengths was inches
- It was noted that the analysis includes the Tx package (host ASIC). Test point is at TP1a. There is no 3rd party PHY in the analysis
- Request to include a slide showing the COM spreadsheet as a reference. Author agreed to give ad hoc Chair ‘01a’ version.
- Chair noted that all three sets of channel are posted in separate zip files under the Chip-to-Module Channels section of the [Tools and Channels](#) page

The ad hoc meeting ended at ~8:20 am Pacific.

List of attendees (captured from Webex tool)

| Name | Affiliation |
|-------------------------|--------------------|
| Adam Healey | Broadcom |
| Adee Ran | Intel |
| Akinwale, Oluwafemi | Intel |
| Alex Haser (Molex) | Molex |
| Ali G | Ghiasi Quantum |
| Arthur Marris (Cadence) | Cadence |
| Athos Kasapi | Cadence |
| Ayal Shoal | Synopsys |
| Bo | Inphi |
| Brandon Gore | Samtec |
| Burrell | Samtec |
| Champion Kao | Intel |
| Clint Walker | Awaveip |
| david malicoat | Senko |
| Frank | Source Photonics |
| Gary Nicholl | Cisco |
| Greg McSorley | Amphenol-Highspeed |
| Howard Heck | Intel |
| Hsinho Wu | Intel |
| John D Ambrosia | Futurewei |
| Jeff Slavick | Broadcom |

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|-----------------------------|---------------|
| Jeff Twombly | Credosemi |
| Jeffery Maki | Juniper |
| Jeremy | Intel |
| John Ewen | Averasemi |
| Kent Lusted | Intel |
| Leon | Huawei |
| Mark Kimber | Semtech |
| Masashi | Intel |
| Matt Brown | Independent |
| Mau-Lin Wu | Mediatek |
| Mike Dudek | Marvell |
| Nathan Tracy | TE |
| Phil Sun | Credosemi |
| Piers | Mellanox |
| pirooz tooyserkani | Cisco |
| Raj Hegde | Broadcom |
| Rich | Samtec |
| Rick Rabinovich | Keysight |
| Scott Sommers | Molex |
| Shawn Nicholl (Xilinx) | Xilinx |
| Shimon | Not available |
| Stephen Didde (Keysight) | Keysight |

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|-----------------------------|-------------|
| Steve Baumgartner | Averasemi |
| Steve Trowbridge (Nokia) | Nokia |
| Tom | Molex/MACOM |
| Xiang | Huawei |
| Yasuo Hidaka | Credosemi |
| Yuchun Lu | Huawei |